TE0807 Test Board

Revision:  v.9
Date:      06.05.2019 16:14
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Online version of this manual and other related documents can be found at https://wiki.trenz-electronic.de/display/PD/Trenz+Electronic+Documentation
Overview

Design Example with minimum PS Setup (DDR, QSPI, UART0) only for custom boards or easier debug via SDK.

Key Features

- QSPI
- SDK
- Custom Carrier (minimum PS Design with available module components only)
- Special FSBL for QSPI Programming

Revision History

<table>
<thead>
<tr>
<th>Date</th>
<th>Vivado</th>
<th>Project Built</th>
<th>Authors</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>2018-01-18</td>
<td>2017.4</td>
<td>TE0807-test_board_noprebuilt-vivado_2017.4-build_05_20180118152119.zip</td>
<td>John Hartfiel</td>
<td>rework Board Part Files</td>
</tr>
<tr>
<td></td>
<td></td>
<td>TE0807-test_board-vivado_2017.4-build_05_20180118152104.zip</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2017-11-14</td>
<td>2017.2</td>
<td>TE0807-test_board_noprebuilt-vivado_2017.2-build_05_20171114115524.zip</td>
<td>John Hartfiel</td>
<td>initial release</td>
</tr>
<tr>
<td></td>
<td></td>
<td>TE0807-test_board-vivado_2017.2-build_05_20171114115511.zip</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Release Notes and Know Issues

<table>
<thead>
<tr>
<th>Issues</th>
<th>Description</th>
<th>Workaround</th>
<th>To be fixed version</th>
</tr>
</thead>
<tbody>
<tr>
<td>No known issues</td>
<td>---</td>
<td>---</td>
<td>---</td>
</tr>
</tbody>
</table>

Requirements

Software

<table>
<thead>
<tr>
<th>Software</th>
<th>Version</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>Vivado</td>
<td>2017.4</td>
<td>needed</td>
</tr>
<tr>
<td>SDK</td>
<td>2017.4</td>
<td>needed</td>
</tr>
</tbody>
</table>

Hardware

Basic description of TE Board Part Files is available on TE Board Part Files.

Complete List is available on <design name>/board_files/*_board_files.csv

Design supports following modules:
<table>
<thead>
<tr>
<th>Module Model</th>
<th>Board Part Short Name</th>
<th>PCB Revision Support</th>
<th>DDR</th>
<th>QSPI Flash</th>
<th>Others</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>TE0807-01-ES2</td>
<td>es2</td>
<td>REV01</td>
<td>2GB</td>
<td>64MB</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Note: Design contains also Board Part Files for TE0807+TEBF0808 configuration, this boart part files are not used for this reference design.

Design supports following carriers:

<table>
<thead>
<tr>
<th>Carrier Model</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>Custom PCB</td>
<td>use simple Board Part files, if MIO connected is different to TEBF0808</td>
</tr>
<tr>
<td>TEBF0808</td>
<td>Used as reference carrier.</td>
</tr>
<tr>
<td>TEBT0808</td>
<td>Change UART0 to UART1 (MIO68...69) and regenerate design</td>
</tr>
</tbody>
</table>

Additional HW Requirements:

<table>
<thead>
<tr>
<th>Additional Hardware</th>
<th>Notes</th>
</tr>
</thead>
</table>

Content

For general structure and of the reference design, see Project Delivery

Design Sources

<table>
<thead>
<tr>
<th>Type</th>
<th>Location</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>Vivado</td>
<td>&lt;design name&gt;/block_design&lt;br&gt;&lt;design name&gt;/constraints&lt;br&gt;&lt;design name&gt;/ip_lib</td>
<td>Vivado Project will be generated by TE Scripts</td>
</tr>
<tr>
<td>SDK/HSI</td>
<td>&lt;design name&gt;/sw_lib</td>
<td>Additional Software Template for SDK/HSI and apps_list.csv with settings for HSI</td>
</tr>
</tbody>
</table>

Additional Sources

<table>
<thead>
<tr>
<th>Type</th>
<th>Location</th>
<th>Notes</th>
</tr>
</thead>
</table>

Prebuilt

<table>
<thead>
<tr>
<th>File</th>
<th>File-Extension</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>BIF-File</td>
<td>*.bif</td>
<td>File with description to generate Bin-File</td>
</tr>
<tr>
<td>BIN-File</td>
<td>*.bin</td>
<td>Flash Configuration File with Boot-Image (Zynq-FPGAs)</td>
</tr>
<tr>
<td>BIT-File</td>
<td>*.bit</td>
<td>FPGA (PL Part) Configuration File</td>
</tr>
<tr>
<td>Diverse Reports</td>
<td>---</td>
<td>Report files in different formats</td>
</tr>
<tr>
<td>Hardware-Platform-Specification-Files</td>
<td>*.hdf</td>
<td>Exported Vivado Hardware Specification for SDK/HSI and PetaLinux</td>
</tr>
<tr>
<td>LabTools Project-File</td>
<td>*.lpr</td>
<td>Vivado Labtools Project File</td>
</tr>
</tbody>
</table>
File | File-Extension | Description
--- | --- | ---
Software-Application-File | *.elf | Software Application for Zynq or MicroBlaze Processor Systems

**Download**

Reference Design is only usable with the specified Vivado/SDK/PetaLinux/SDx version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

- TE0807 "Test Board" Reference Design
Design Flow

⚠️ Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first lunch.

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

See also:

- Vivado/SDK/SDSoC#XilinxSoftware-BasicUserGuides
- Vivado Projects
- Project Delivery.

The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with ".create_win_setup.cmd" on Windows OS and ".create_linux_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also executed by Xilinx Vivado/SDK GUI. For currently Scripts limitations on Win and Linux OS see: Project Delivery Currently limitations of functionality

1. ".create_win_setup.cmd/".create_linux_setup.sh and follow instructions on shell:

2. Press 0 and enter for minimum setup
3. (optional Win OS) Generate Virtual Drive or use short directory for the reference design (for example x:\<design name>)
4. Create Project
   a. Select correct device and Xilinx install path on "design_basic_settings.cmd" and create Vivado project with "vivado_create_project_guimode.cmd"
   Note: Select correct one, see TE Board Part Files
   Important: Use Board Part Files, which did not ends with "_.tebf0808"
5. Create HDF and export to prebuilt folder
   a. Run on Vivado TCL: TE::hw_build_design -export_prebuilt
      Note: Script generate design and export files into \prebuilt\hardware\<short dir>. Use GUI is the same, except file export to prebuilt folder

6. Generate Programming Files with HSI/SDK
   a. Run on Vivado TCL: TE::sw_run_hsi
      Note: Scripts generate applications and bootable files, which are defined in "sw_lib\apps_list.csv"
   b. (alternative) Start SDK with Vivado GUI or start with TE Scripts on Vivado TCL: TE::
      sw_run_sdk
      Note: See SDK Projects
Launch

Programming

⚠️ Check Module and Carrier TRMs for proper HW configuration before you try any design.

Xilinx documentation for programming and debugging: [Vivado/SDK/SDSoC-Xilinx Software Programming and Debugging](http://www.trenz-electronic.de)

**QSPI**

1. Connect JTAG and power on carrier with module
2. Open Vivado Project with "vivado_open_existing_project_gui_mode.cmd" or if not created, create with "vivado_create_project_gui_mode.cmd"
3. Type on Vivado TCL Console: `TE::pr_program_flash_binfile -swapp hello_te0807`
   Note: To program with SDK/Vivado GUI, use special FSBL (zynqmp_fsbl_flash) on setup

Use SDK instead of Vivado is also possible, see: [SDK Projects#Xilinx%22HelloWorld%22onZynqMP](http://www.trenz-electronic.de)

**SD**

This does not work, because SD controller is not selected on PS.

**JTAG**

Load configuration and Application with SDK Debugger into device, see:

- SDK Projects
- SDK Projects#DebugSoftwareApplication

**Usage**

**QSPI Boot:**

1. Prepare HW like described on section Programming
2. Connect UART USB (most cases same as JTAG)
3. Select QSPI Card as Boot Mode
   Note: See TRM of the Carrier, which is used.
4. Power On PCB
   Note: 1. ZynqMP Boot ROM loads PMU Firmware and FSBL from QSPI into OCM, 2. FSBL loads Application into DDR

Debugging:
- SDK Projects
- SDK Projects#DebugSoftwareApplication
System Design - Vivado

Block Design

PS Interfaces

Activated interfaces:

<table>
<thead>
<tr>
<th>Type</th>
<th>Note</th>
</tr>
</thead>
<tbody>
<tr>
<td>DDR</td>
<td></td>
</tr>
<tr>
<td>QSPI</td>
<td>MIO</td>
</tr>
<tr>
<td>UART0</td>
<td>MIO, please select other one, if you have connected uart to second controller or other MIO</td>
</tr>
<tr>
<td>SWDT0..1</td>
<td></td>
</tr>
<tr>
<td>TTC0..3</td>
<td></td>
</tr>
</tbody>
</table>

Constrains

Basic module constrains

```plaintext
-i_bitgen.xdc

set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]
set_property BITSTREAM.CONFIG.UNUSEDPIN PULLNONE [current_design]
```

Design specific constrain

Not needed.
Software Design - SDK/HSI

For SDK project creation, follow instructions from:

SDK Projects

Application

zynqmp_fsbl

Xilinx default FSBL

zynqmp_fsbl_flash

TE modified 2017.4 FSBL

Changes:

- Set FSBL Boot Mode to JTAG
- Disable Memory initialisation

Hello TE0807

Hello TE0807 is a Xilinx Hello World example as endless loop instead of one console output.
Additional Software

No additional software is needed.
Appx. A: Change History and Legal Notices

Document Change History

To get content of older revision got to "Change History" of this page and select older document revision number.

<table>
<thead>
<tr>
<th>Date</th>
<th>Document Revision</th>
<th>Authors</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>2019-02-07</td>
<td>v.9</td>
<td>John Hartfiel</td>
<td>Release 2017.4</td>
</tr>
<tr>
<td>2017-11-14</td>
<td>v.3</td>
<td>John Hartfiel</td>
<td>Release 2017.2</td>
</tr>
<tr>
<td>All</td>
<td></td>
<td>John Hartfiel</td>
<td></td>
</tr>
</tbody>
</table>

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2018-09-18